

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Sang-II Hwang</td><td>05/21/2007</td></tr><tr><td>Hyun Ju Lim</td><td>05/21/2007</td></tr></tbody></table>	Name	Execution Date	Sang-II Hwang	05/21/2007	Hyun Ju Lim	05/21/2007					
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Sang-II Hwang	05/21/2007										
Hyun Ju Lim	05/21/2007										
RECEIVING PARTY DATA											
<table border="1"><tr><td>Name:</td><td>Dongbu HiTek Co., Ltd.</td></tr><tr><td>Street Address:</td><td>891-10 Daechi-dong, Gangnam-gu</td></tr><tr><td>City:</td><td>Seoul</td></tr><tr><td>State/Country:</td><td>KOREA, REPUBLIC OF</td></tr><tr><td>Postal Code:</td><td>135-280</td></tr></table>	Name:	Dongbu HiTek Co., Ltd.	Street Address:	891-10 Daechi-dong, Gangnam-gu	City:	Seoul	State/Country:	KOREA, REPUBLIC OF	Postal Code:	135-280	
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PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11752625</td></tr></tbody></table>	Property Type	Number	Application Number:	11752625							
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Application Number:	11752625										
CORRESPONDENCE DATA											
Fax Number: (703)935-8473 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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ATTORNEY DOCKET NUMBER:	603-0032										
NAME OF SUBMITTER:	Daniel H. Sherr										
Total Attachments: 3 source=20070523170923#page1.tif source=20070523170923#page2.tif											

OP \$40.00 11752625

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PATENT
REEL: 019335 FRAME: 0062

Docket No.: 603-0032
Application No.: 11/752,625
Filing Date: May 23, 2007

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Sang-II HWANG residing at 891-10 Daechi-dong, Gangnam-gu, Seoul, Korea; and
- 2) Hyun Ju LIM residing at 891-10 Daechi-dong, Gangnam-gu, Seoul, Korea

who has made certain new and useful inventions, hereby sell, assign and transfer unto

Dongbu HiTek Co., Ltd.

having an address at

891-10 Daechi-dong, Gangnam-gu, Seoul, Korea;

its successors and assigns (hereinafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

METHOD OF FORMING DUAL DAMASCENE PATTERN.

for which an application for a United States Patent was filed on May 23, 2007,
identified as U.S. Patent Serial Number 11/752,625,

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and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and/or that claim priority thereto and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof and/or that claim priority thereto, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, and associated foreign patent applications, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

AND the undersigned hereby grants the firm of SHERR & NOURSE, PLLC the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of any issuing authority, including the United States Patent and Trademark Office, for recordation of this document.

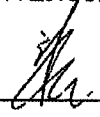
SIGNED on the dates indicated aside our signatures:

Docket No.: 603-0032
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INVENTOR

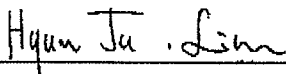
DATE

1)


Sang-II HWANG

07.05.21

2)


Hyeon Ju LIM

07.05.21